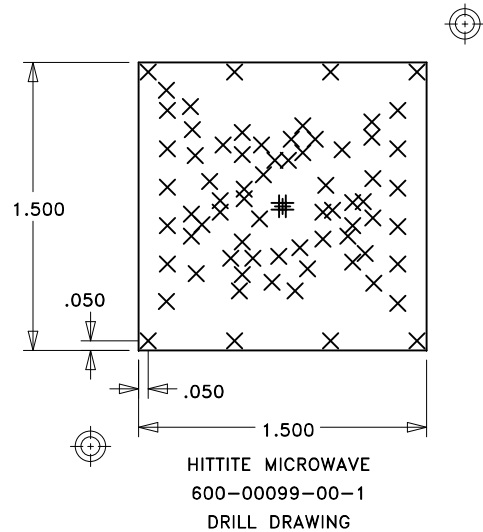


REVISION			
LTR	DESCRIPTION	DATE	APPROVED
1	ENGINEERING RELEASE	02/11/10	V. LY



SIZE	QTY	SYM	PLATED	TOL
10	5	+	YES	+/-3
14	71	X	YES	+/-3

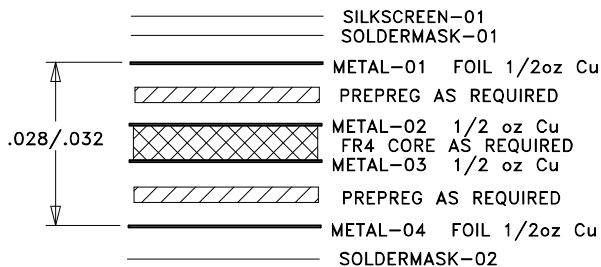
NOTES:

UNLESS OTHERWISE SPECIFIED:

1. MATERIAL: MULTILAYER. OVERALL STACKUP AS SHOWN. TYPE FR4, HALF OUNCE COPPER BOTH SIDES.
2. FINISH: GOLD PLATE PER ASTM B-488, TYPE III, CODE A, 8 TO 40 MICROINCHES, OVER NICKEL PER QQ-N-290, 100 MICROINCHES MINIMUM.
3. PLATED THRU HOLES: .001 MINIMUM WALL THICKNESS.
4. HOLE SIZES AND POSITIONS PER ARTWORK AND/OR DRILL FILE.
5. ALL HOLES TO BE LOCATED WITHIN ± 0.003 OF THE CENTER OF THE PAD OR OTHER TRUE POSITION.
6. FRONT TO BACK REGISTRATION ± 0.003 MAX.
7. BOARD WARPAGE: $< .010$ PER LINEAR INCH.
8. SILKSCREEN TOP SIDE ONLY WITH WHITE EPOXY INK.
9. SOLDERMASK: LPI SOLDERMASK BOTH SIDES. COLOR: GREEN REGISTRATION: ± 0.004 MAX. SOLDERMASK TOP: NEGATIVE IMAGE. SOLDERMASK BOTTOM: POSITIVE IMAGE, BOTTOM SURFACE TO BE FREE OF SOLDERMASK EXCEPT FOR THE AREAS DEFINED.
10. "SIZE" IN DRILL LEGEND IS IN MILS AND REFERS TO FINISHED HOLE SIZE.
11. MANUFACTURE PER IPC-6012 CLASS 2.

VENDOR NOTES:

12. VENDOR MAY ADD E-TEST STAMP TO PCB. VENDOR SHALL NOT ADD NAME, LOGO, DATE CODE, UL LISTING OR ANY OTHER MARKING TO ANY VISIBLE LAYER.
13. BOARDS MUST PASS VISUAL INSPECTION PER IPC-A-600 CLASS 2.



LAYER STACKUP

UNLESS OTHERWISE SPECIFIED:	
DIMENSIONS ARE IN INCHES [mm]	
DRAWING PRACTICES PER ASME Y14.100	
INTERPRET DIMENSIONS & TOLERANCES PER ASME Y14.5-2009	
TOLERANCES:	
.XX	$\pm .01$
.XXX	$\pm .005$
.XXXX	$\pm .0020$
ANGLES	$\pm .5$ DEG.

NEXT ASSY	XXXXXX USED ON
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DRAWN BY V. LY	DATE DRN 02/07/11
CHECKED BY	
ENGINEER S. ILKE	02/07/11
THIRD ANGLE PROJECTION	
DO NOT SCALE DRAWING	

PROPRIETARY TO HITTITE MICROWAVE CORPORATION



HITTITE MICROWAVE CORPORATION
20 Alpha Road
Chelmsford, MA 01824

TITLE

PCB, EVAL

SIZE	CODE ID NO.	DWG NO.	REV
A	1CN88	600-00099-00	1
SCALE: 1:1		WT:	SHEET: 1 OF 1